# **PRODUCT SPECIFICATION**





- < >> Preliminary Specification
- < ◆> Finally Specification

	CUSTOMER'S APPROVAL						
CUSTOMER:	CUSTOMER:						
SIG	NATURE:	DATE:					

APPROVED	PM	PD	PREPARED
ВҮ	REVIEWED	REVIEWED	BY
S. G. H			TFT
20220706			20220706

knitter-switch

# **Revision History**

Revision	Date	Originator	Detail	Remarks
1.0	2022.07.06	LQ	Initial Release	

# **Table of Contents**

No. Item	Page
1. General Description	4
2. Module Parameter	4
3. Absolute Maximum Ratings	4
4. DC Characteristics	5
5. Backlight Characteristic	5
5.1. Backlight Characteristics	5
5.2. Backlighting circuit	5
6. Optical Characteristics	6
6.1. Optical Characteristics	6
6.2. Definition of Response Time	6
6.3. Definition of Contrast Ratio	7
6.4. Definition of Viewing Angles	7
6.5. Definition of Color Appearance	8
6.6. Definition of Surface Luminance, Uniformity and Transmittance	8
7. Block Diagram and Power Supply	9
8. Interface Pins Definition	10
9. AC Characteristics	11
10. Quality Assurance	14
10.1. Purpose	14
10.2. Standard for Quality Test	14
10.3. Nonconforming Analysis & Disposition	14
10.4. Agreement Items	14
10.5. Standard of the Product Visual Inspection	14
10.6. Inspection Specification	15
10.7. Classification of Defects	19
10.8. Identification/marking criteria	19
10.9. Packing	19
11. Reliability Specification	20
12. Precautions and Warranty	21
12.1. Safety	21
12.2. Handling	21
12.3. Storage	21
12.4. Metal Pin (Apply to Products with Metal Pins)	21
12.5. Operation	22
12.6. Static Electricity	22
12.7. Limited Warranty	22
13. Packaging	23
14. Outline Drawing	24

# 1. General Description

The specification is a transmissive type color active matrix liquid crystal display (LCD) which uses amorphous thin film transistor (TFT) as switching devices. This product is composed of a TFT-LCD panel, driver ICs and a backlight unit.

## 2. Module Parameter

Features	Details	Unit
Display Size(Diagonal)	4.6"	
LCD type	IPS TFT	
Display Mode	Normally Black/Transmissive	
Resolution	320 RGB x 960	Pixels
View Direction	Full Viewing	Best Image
Module Outline	41.57 (H) x 118.80(V) x 2.50(T) (Note1)	mm
Active Area	36.768 (H) x 110.304(V)	mm
Pixel Size	114.9(H) x 114.9(V)	um
Pixel Arrangement	R.G.B Vertical Stripe	
Display Colors	16.7M	
Interface	2 Lane MIPI Interface	
Driver IC	ST7701S	
With or Without Touch Panel	Without	
Operating Temperature	-20~70	°C
Storage Temperature	-30~80	°C
Weight	26	g

Note 1: Exclusive hooks, posts, FFC/FPC tail etc.

# 3. Absolute Maximum Ratings

GND=0V, Ta=25°C

Item	Symbol	Min.	Max.	Unit
Cupply Voltage	VDDA	-0.3	4.6	V
Supply Voltage	VDDIO	-0.3	4.6	V
Storage temperature	T <sub>STG</sub>	-30	+80	°C
Operating temperature	T <sub>OP</sub>	-20	+70	°C

Note 1: If Ta below 50°C, the maximal humidity is 90%RH, if Ta over 50°C, absolute humidity should be less than 60%RH.

Note 2: The response time will be extremely slow when the operating temperature is around -10 $^{\circ}$ C, and the back ground will become darker at high temperature operating.

## 4. DC Characteristics

Item	Symbol	Min.	Тур.	Max.	Unit
Supply Voltage	VDDA	2.5	2.8	3.6	V
Supply Voltage	VDDIO	1.65	1.8	3.3	V
Logic Low input voltage	V <sub>IL</sub>	GND	-	0.3*VDDIO	V
Logic High input voltage	V <sub>IH</sub>	0.7*VDDIO	-	VDDIO	V
Logic Low output voltage	V <sub>OL</sub>	GND	-	0.2*VDDIO	V
Logic High output voltage	V <sub>OH</sub>	0.8*VDDIO	-	VDDIO	V
Current Consumption All White	I <sub>VCI</sub> +I <sub>IOVCC</sub>	-	80	-	mA

# 5. Backlight Characteristic

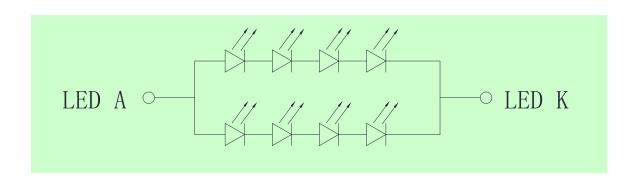
## 5.1. Backlight Characteristics

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Forward Voltage	VF	Ta=25 °C, I <sub>F</sub> =20mA/LED	10.8	12.0	13.2	V
Forward Current	lF	Ta=25 °C, V <sub>F</sub> =3.0V/LED	-	40	-	mA
Power dissipation	Po	-	-	480	-	mW
Uniformity	Avg	-	-	80	-	%
LED working life(25°C)			-	30000	-	Hrs
Drive method	Constant current					
LED Configuration		8 White LEDs ( 4 LEDs in string	and 2 gr	oups in pa	rallel)	

Note: LED life time defined as follows: The final brightness is at 50% of original brightness.

The environmental conducted under ambient air flow, at Ta=25±2 °C,60%RH±5%, I<sub>F</sub>=20mA/LED.

## 5.2. Backlighting circuit



# 6. Optical Characteristics

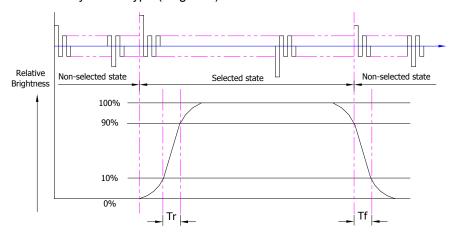
## 6.1. Optical Characteristics

Ta=25°C, VDDA=2.8V

	Item		Symbol	Condition	S	pecificati	on	Unit
			Symbol Condition		Min.	Тур.	Max.	Unit
	Luminan	ce on						
	$TFT(I_f = 20r$	mA/LED)	Lv	Normally	360	450	-	cd/m²
ge	Contrast ratio	(See 6.3)	CR	viewing angle	1000	1200	-	
Backlight On (Transmissive Mode)	Response time (See 6.2)		$\theta x = \phi Y = 0^{\circ}$	-	25	35	ms	
l ä		Red	XR		0.545	0.595	0.645	
ans		Reu	YR		0.284	0.334	0.384	
Ë		Green	Xg		0.273	0.323	0.373	
l e	Chromaticity	Green	YG		0.554	0.604	0.654	
Ħ	Transmissive	Blue	Хв		0.087	0.137	0.187	
<u>₹</u>	(See 6.5)	Diue	YB		0.051	0.101	0.151	
3ac		\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	Xw		0.237	0.287	0.337	
"		White	Yw		0.269	0.319	0.369	
		Harizantal	θx+		70	80	-	
	Viewing Angle	Horizontal	θх-	Contor CD>40	70	80	-	<sub>  Dog</sub>
	(See 6.4)	Vertical	фҮ+	Center CR≥10	70	80	-	Deg.
		vertical	φY-		70	80	-	
	NTSC Ratio	(Gamut)			45	50	-	%

# 6.2. Definition of Response Time

## 6.2.1. Normally Black Type (Negative)

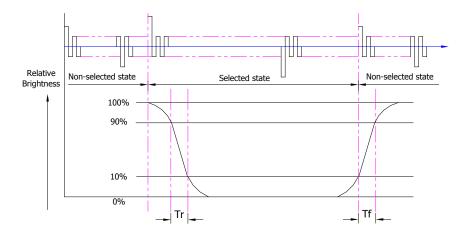


Tr is the time it takes to change form non-selected stage with relative luminance 10% to selected state with relative luminance 90%;

Tf is the time it takes to change from selected state with relative luminance 90% to non-selected state with relative luminance 10%

Note: Measuring machine: LCD-5100

## 6.2.2. Normally White Type (Positive)



Tr is the time it takes to change form non-selected stage with relative luminance 90% to selected state with relative luminance 10%;

Tf is the time it takes to change from selected state with relative luminance 10% to non-selected state with relative luminance 90%;

Note: Measuring machine: LCD-5100 or EQUI

## 6.3. Definition of Contrast Ratio

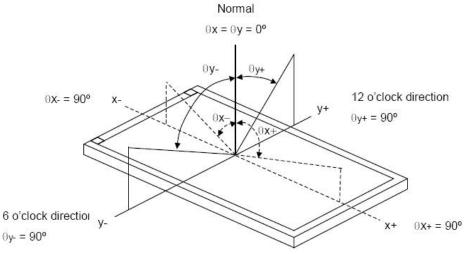
Contrast is measured perpendicular to display surface in reflective and transmissive mode.

The measurement condition is:

Measuring Equipment	Eldim or Equivalent		
Measuring Point Diameter	3mm//1mm		
Measuring Point Location	Active Area centre point		
Toot nottorn	A: All Pixels white		
Test pattern	B: All Pixel black		
Contrast setting	Maximum		

Definitions: CR (Contrast) = Luminance of White Pixel / Luminance of Black Pixel

## 6.4. Definition of Viewing Angles

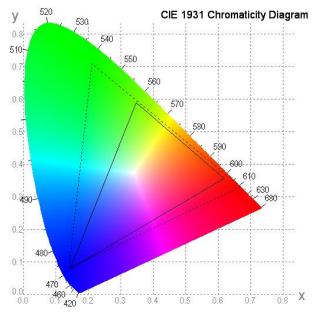


Measuring machine: LCD-5100 or EQUI

## 6.5. Definition of Color Appearance

R,G,B and W are defined by (x, y) on the IE chromaticity diagram NTSC=area of RGB triangle/area of NTSC triangleX100%

Measuring picture: Red, Green, Blue and White (Measuring machine: BM-7)

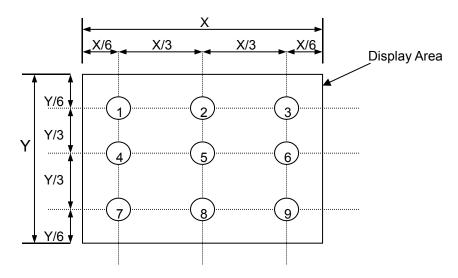


## 6.6. Definition of Surface Luminance, Uniformity and Transmittance

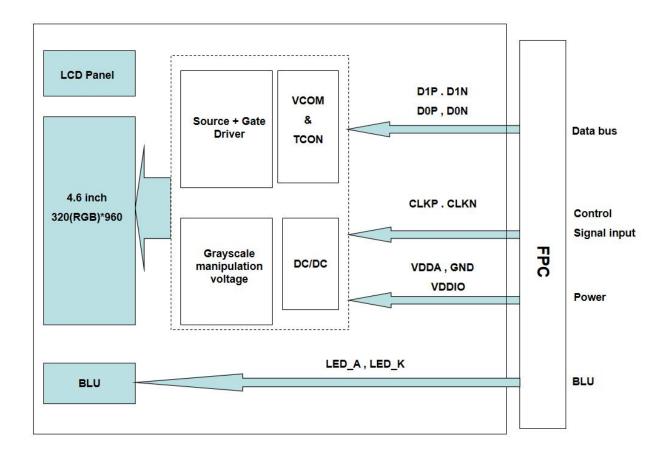
Using the transmissive mode measurement approach, measure the white screen luminance of the display panel and backlight.

- 6.6.1. Surface Luminance:  $L_V$  = average ( $L_{P1}$ : $L_{P9}$ )
- 6.6.2. Uniformity = Minimal  $(L_{P1}:L_{P9})$  / Maximal  $(L_{P1}:L_{P9})$  \* 100%
- 6.6.3. Transmittance =  $L_V$  on LCD /  $L_V$  on Backlight \* 100%

Note: Measuring machine: BM-7



# 7. Block Diagram and Power Supply

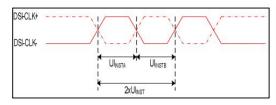


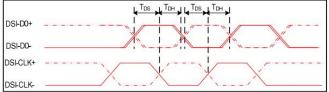
# 8. Interface Pins Definition

No.	Symbol	Function	Remark
1	GND	Ground	
2	VDDA	Operating voltage	
3	VDDIO	I/O Supply Voltage	
4	GND	Ground	
5	D1P	MIPI DSI differential data pair	
6	D1N	MIPI DSI differential data pair	
7	GND	Ground	
8	CLKP	MIPI DSI differential clock pair	
9	CLKN	MIPI DSI differential clock pair	
10	GND	Ground	
11	D0P	MIPI DSI differential data pair	
12	D0N	MIPI DSI differential data pair	
13	GND	Ground	
14	LED_A	LED Anode	
15	LED_K	LED Cathode	

## 9. AC Characteristics

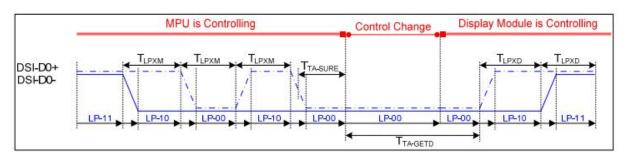
# 1) High Speed Mode - Clock Channel Timing

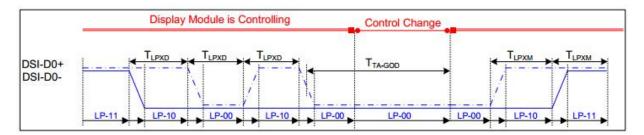




Signal	Symbol	Parameter	MIN	MAX	Unit	Description
DSI-CLK+/-	2xUIInsta	Double UI instantaneous	2.5	25	ns	
DSI-CLK+/-	UI <sub>INSTA</sub> UI <sub>INSTB</sub>	UI instantaneous halfs	1.25	12.5	ns	UI = UI <sub>INSTA</sub> = UI <sub>INSTB</sub>
DSI-Dn+/-	tDS	Data to clock setup time	0.15	2	UI	
DSI-Dn+/-	tDH	Data to clock hold time	0.15	-	UI	

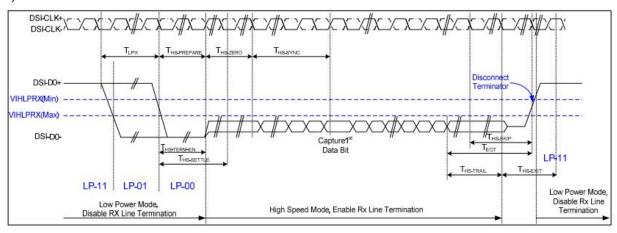
## 2) Low Speed Mode - Bus Turn Around

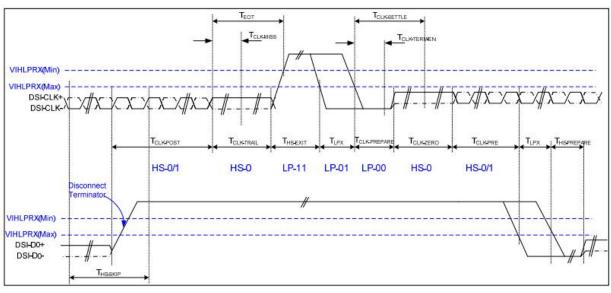




Signal Symbol Parameter		Parameter MIN N		MAX	Unit	Description	
DSI-D0+/- TLPXM		Length of LP-00,LP-01, LP-10 or LP-11 periods MPU→Display Module	50 75		ns	Input	
DSI-D0+/-	TLPXD	Length of LP-00,LP-01, LP-10 or LP-11 periods MPU→Display Module	50 75 ns		ns	Output	
DSI-D0+/-	TTA-SURED	Time-out before the MPU start driving	T <sub>LPXD</sub> 2xT <sub>LP</sub>		ns	Output	
DSI-D0+/-	TTA-GETD	Time to drive LP-00 by display module	5xT <sub>LPXD</sub>		ns	Input	
DSI-D0+/-	TTA-GOD	Time to drive LP-00 after turnaround request-MPU	4xT <sub>LPXD</sub>		ns	Output	

### 3) DSI Burst Mode





Signal	Symbol	Parameter	MIN	MAX	Unit	Description
		Low Power Mode to High Speed Mo	ode Timi	ng		
DSI-Dn+/-	TLPX	Length of any low power state period	50	533	ns	Input
DSI-Dn+/-	THS-PREPARE	Time to drive LP-00 to prepare for HS transmission	40+4 UI	85+6 UI	ns	Input
DSI-Dn+/-	THS-TERM-EN	Time to enable data receiver line termination measured from when Dn crosses VILMAX	line termination measured from -		ns	Input
DSI-Dn+/-	THS-PREPARE + THS-ZERO	THS-PREPARE + time to drive HS-0 before the sync sequence			ns	Input
	14	High Speed Mode to Low Power Mo	ode Timi	ng		
DSI-Dn+/-	THS-SKIP	Time-out at display module to ignore transition period of EoT	40	55+4 UI	ns	Input
DSI-Dn+/-	THS-EXIT	Time to drive LP-11 after HS burst	100	V.=31	ns	Input
DSI-Dn+/-	THS-TRAIL	Time to drive flipped differential 6 state after last payload data bit of a HS transmission burst		523	ns	Input
	Hig	gh Speed Mode to/from Low Power	Mode Ti	iming		
DSI-CLK+/-	TCLK-POS	Time that the MPU shall continue sending HS clock after the last associated data lane has transition to LP mode	60+5 2UI	1.30	ns	Input
DSI-CLK+/-	TCLK-TRAIL	Time to drive HS differential state after last payload clock bit of a HS transmission burst	60	388	ns	Input
DSI-CLK+/-	THS-EXIT	Time to drive LP-11 after HS burst	100	1.2	ns	Input
DSI-CLK+/-	TCLK-PREPARE	Time to drive LP-00 to prepare for HS transmission	38	95	ns	Input
DSI-CLK+/-	TCLK-TERM-EN	Time-out at clock lan display module to enable HS transmission	-	38	ns	Input
DSI-CLK+/-	TCLK-PREPARE + TCLK-ZERO	Minimum lead HS-0 drive period before starting clock	300	949	ns	Input
DSI-CLK+/-	TCLK-PRE	Time that the HS clock shall be driven prior to any associated data lane beginning the transition from LP to HS mode	8UI	383	ns	Input
		1,114,1 111,111,111,111,111,111,111,111,		105n		

## 10. Quality Assurance

## 10.1.Purpose

This standard for Quality Assurance assures the quality of LCD module products supplied to customer.

### 10.2. Standard for Quality Test

10.2.1. Sampling Plan:

GB2828.1-2012

Single sampling, general inspection level II

10.2.2. Sampling Criteria:

Visual inspection: AQL 1.5

Electrical functional: AQL 0.65.

10.2.3. Reliability Test:

Detailed requirement refer to Reliability Test Specification.

### 10.3. Nonconforming Analysis & Disposition

- 10.3.1. Nonconforming analysis:
  - 10.3.1.1. Customer should provide overall information of non-conforming sample for their complaints.
  - 10.3.1.2. After receipt of detailed information from customer, the analysis of nonconforming parts usually should be finished in one week.
  - 10.3.1.3. If can not finish the analysis on time, customer will be notified with the progress status.
- 10.3.2. Disposition of nonconforming:
  - 10.3.2.1. Non-conforming product over PPM level will be replaced.
  - 10.3.2.2. The cause of non-conformance will be analyzed. Corrective action will be discussed and implemented.

### 10.4. Agreement Items

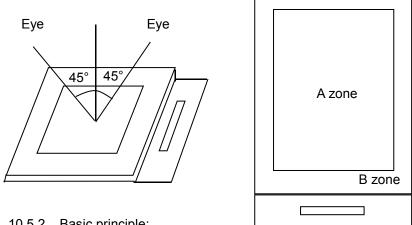
Shall negotiate with customer if the following situation occurs:

- 10.4.1. There is any discrepancy in standard of quality assurance.
- 10.4.2. Additional requirement to be added in product specification.
- 10.4.3. Any other special problem.

## 10.5. Standard of the Product Visual Inspection

- 10.5.1. Appearance inspection:
  - 10.5.1.1. The inspection must be under illumination about  $1000 1500 \, lx$ , and the distance of view must be at  $30 \, cm \pm 2 \, cm$ .
  - 10.5.1.2. The viewing angle should be 45° from the vertical line without reflection light or follows customer's viewing angle specifications.

10.5.1.3. Definition of area: A Zone: Active Area, B Zone: Viewing Area,



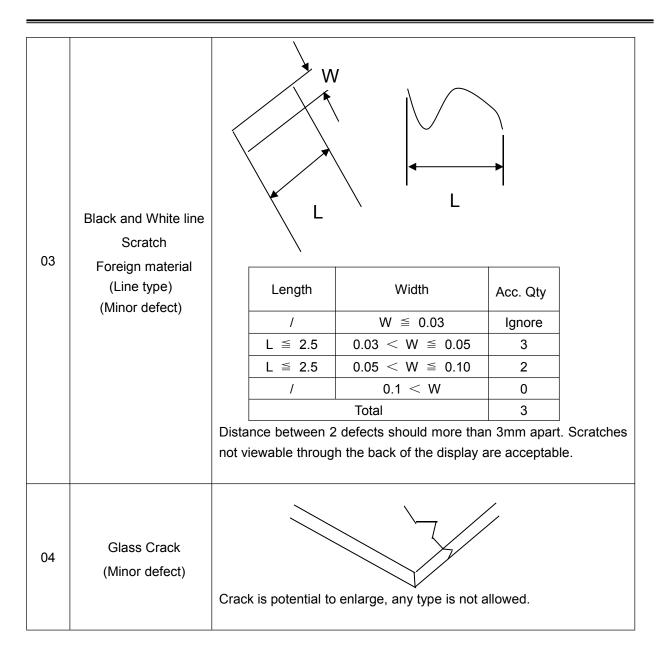
10.5.2. Basic principle:

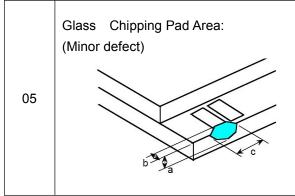
10.5.2.1. A set of sample to indicate the limit of acceptable quality level must be discussed by both us and customer when there is any dispute happened.

10.5.2.2. New item must be added on time when it is necessary.

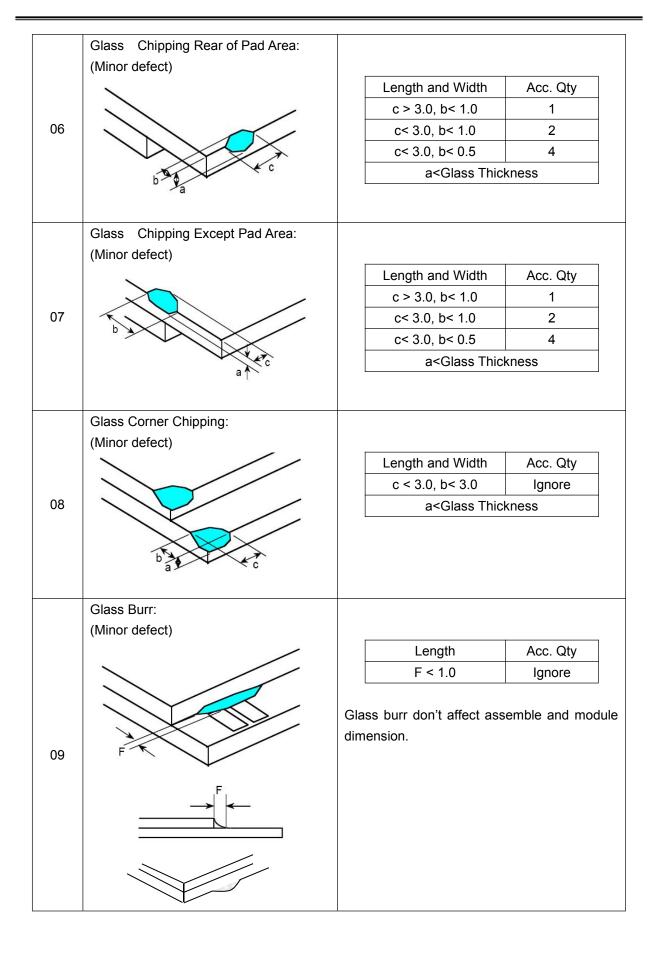
# 10.6.Inspection Specification

No.	Item	Criteria (Unit: mm)					
01	Black / White spot Foreign material (Round type) Pinholes Stain Particles inside cell. (Minor defect)	φ= (a + b) /2 Distance between 2 defects should more than 3mm apart.	0.10<φ≤ 0.15<φ≤ 0.25<	Area Size  φ≤0.10  0.10<φ≤0.15  0.15<φ≤0.25  0.25<φ  Total		Acc. Qty  Ignore  2  1  0  2 no include  φ≤ 0.10	
02	Electrical Defect (Minor defect)	Bright dot  Dark dot  Total dot	0 N≤2 N≤2 Not visible throu	N N ugh 5% NI		Note 1 Note 2 to item 1.	





Length and Width	Acc. Qty			
c > 3.0, b< 1.0	1			
c< 3.0, b< 1.0				
a <glass td="" thickness<=""></glass>				



	FPC Defect:(Minor d	efect)				
10	$w \rightarrow 0$	(w: circu 10.2 Op	<ul><li>10.1 Dent, pinhole width a<w 3.<="" li=""><li>(w: circuitry width.)</li><li>10.2 Open circuit is unacceptable.</li><li>10.3 No oxidation, contamination and distortion</li></w></li></ul>			
11	Bubble on Polarizer (Minor defect)		Diamete φ≤0.20 0.20 <φ≤0 0.30 < φ	.30	Acc. Qty Ignore 4 None	
12	Dent on Polarizer (Minor defect)		Diamete φ≤0.20 0.20 <φ≤0 0.30 < φ	.30	Acc. Qty Ignore 4 None	
13	Bezel  13.1 No rust, distortion on the Bezel.  13.2 No visible fingerprints, stains or other contamination.				ion.	
14	PCB	14.1 No distortion or contamination on PCB terminals. 14.2 All components on PCB must same as documented on the BOM/component layout. 14.3 Follow IPC-A-600F.				
15	Soldering	Follow IPC-A-610C standard				
16	Electrical Defect (Major defect)	The below defects must be rejected.  16.1 Missing vertical / horizontal segment,  16.2 Abnormal Display.  16.3 No function or no display.  16.4 Current exceeds product specifications.  16.5 LCD viewing angle defect.  16.6 No Backlight.  16.7 Dark Backlight.  16.8 Touch Panel no function.				

Remark: LCD Panel Broken shall be rejected. Defect out of LCD viewing area is acceptable.

#### 10.7. Classification of Defects

- 10.7.1. Visual defects (Except no / wrong label) are treated as minor defect and electrical defect is major.
- 10.7.2. Two minor defects are equal to one major in lot sampling inspection.

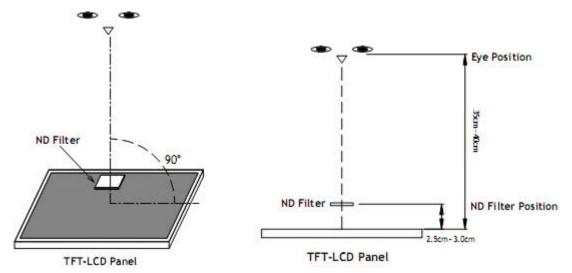
#### 10.8.Identification/marking criteria

Any unit with illegible / wrong /double or no marking/ label shall be rejected.

### 10.9. Packing

- 10.9.1. There should be no damage of the outside carton box, each packaging box should have one identical label.
- 10.9.2. Modules inside package box should have compliant mark.
- 10.9.3. All direct package materials shall offer ESD protection.

Note1: Bright dot is defined as the defective area of the dot is larger than 50% of one sub-pixel area.



Bright dot: The bright dot size defect at black display pattern. It can be recognized by 2% transparency of filter when the distance between eyes and panel is  $350 \text{mm} \pm 50 \text{mm}$ .

Dark dot: Cyan, Magenta or Yellow dot size defect at white display pattern. It can be recognized by 5% transparency of filter when the distance between eyes and panel is  $350 \text{mm} \pm 50 \text{mm}$ .

**Note2:** Mura on display which appears darker / brighter against background brightness on parts of display area.

# 11. Reliability Specification

No	ltem	Condition	Quantity	Criteria
1	High Temperature Operating	<b>70℃</b> , 96Hrs	2	GB/T2423.2 -2008
2	Low Temperature Operating	-20℃, 96Hrs	2	GB/T2423.1 -2008
3	High Humidity Storage	50℃, 90%RH, 96Hrs	2	GB/T2423.3 -2016
4	High Temperature Storage	80℃, 96Hrs	2	GB/T2423.2 -2008
5	Low Temperature Storage	-30℃, 96Hrs	2	GB/T2423.1 -2008
6	Thermal Cycling Test Storage	-20℃, 60min~70℃, 60min, 20 cycles.	2	GB/T2423.22 -2012
7	Packing vibration	Frequency range:10Hz~50Hz Acceleration of gravity:5G X, Y, Z 30 min for each direction.	-	GB/T5170.14 -2009
8	Electrical Static Discharge	Air: $\pm$ 8KV 150pF/330 $\Omega$ 5 times	2	GB/T17626.2
°		Contact: $\pm$ 4KV 150pF/330 $\Omega$ 5 times	2	-2018
9	Drop Test (Packaged)	Height:80 cm,1 corner, 3 edges, 6 surfaces.	-	GB/T2423.8 -1995

Note1. No defection cosmetic and operational function allowable.

Note2. Total current Consumption should be below double of initial value.

## 12. Precautions and Warranty

## 12.1. Safety

- 12.1.1. The liquid crystal in the LCD is poisonous. Do not put it in your mouth. If the liquid crystal touches your skin or clothes, wash it off immediately using soap and water.
- 12.1.2. Since the liquid crystal cells are made of glass, do not apply strong impact on them. Handle with care.

#### 12.2. Handling

- 12.2.1. Reverse and use within ratings in order to keep performance and prevent damage.
- 12.2.2. Do not wipe the polarizer with dry cloth, as it might cause scratch. If the surface of the LCD needs to be cleaned, wipe it swiftly with cotton or other soft cloth soaked with petroleum IPA, do not use other chemicals.

### 12.3.Storage

- 12.3.1. Do not store the LCD module beyond the specified temperature ranges.
- 12.3.2. Strong light exposure causes degradation of polarizer and color filter.

## 12.4. Metal Pin (Apply to Products with Metal Pins)

12.4.1. Pins of LCD and Backlight

12.4.1.1. Solder tip can touch and press on the tip of Pin LEAD during the soldering

12.4.1.2. Recommended Soldering Conditions

Solder Type: Sn96.3~94-Ag3.3~4.3-Cu0.4~1.1

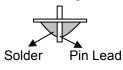
Maximum Solder Temperature: 370 ℃

Maximum Solder Time: 3s at the maximum temperature

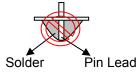
Recommended Soldering Temp: 350±20 ℃

Typical Soldering Time: ≤3s

12.4.1.3. Solder Wetting



Recommended



Not Recommended

#### 12.4.2. Pins of EL

12.4.2.1. Solder tip can touch and press on the tip of EL leads during soldering.

12.4.2.2. No Solder Paste on the soldering pad on the motherboard is recommended.

12.4.2.3. Recommended Soldering Conditions

Solder type: Nippon Alimit Leadfree SR-34, size 0.5mm

Recommended Solder Temperature: 270~290 ℃

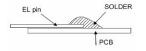
Typical Soldering Time: ≤2s

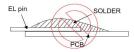
Minimum solder distance from EL lamp (body):2.0mm

12.4.2.4. No horizontal press on the EL leads during soldering.

12.4.2.5. 180° bend EL leads three times is not allowed.

#### 12.4.2.6. Solder Wetting





Recommended

Not Recommended

12.4.2.7. The type of the solder iron:





Recommended

Not Recommended

12.4.2.8. Solder Pad



## 12.5. Operation

- 12.5.1. Do not drive LCD with DC voltage
- 12.5.2. Response time will increase below lower temperature
- 12.5.3. Display may change color with different temperature
- 12.5.4. Mechanical disturbance during operation, such as pressing on the display area, may cause the segments to appear "fractured".
- 12.5.5. Do not connect or disconnect the LCM to or from the system when power is on.
- 12.5.6. Never use the LCM under abnormal condition of high temperature and high humidity.
- 12.5.7. Module has high frequency circuits. Sufficient suppression to the electromagnetic interface shall be done by system manufacturers. Grounding and shielding methods may be important to minimize the interference.
- 12.5.8. Do not display the fixed pattern for long time (we suggest the time not longer than one hour) because it will develop image sticking due to the TFT structure.

#### 12.6. Static Electricity

- 12.6.1. CMOS LSIs are equipped in this unit, so care must be taken to avoid the electro-static charge, by ground human body, etc.
- 12.6.2. The normal static prevention measures should be observed for work clothes and benches.
- 12.6.3. The module should be kept into anti-static bags or other containers resistant to static for storage.

#### 12.7. Limited Warranty

- 12.7.1. Our warranty liability is limited to repair and/or replacement. We will not be responsible for any consequential loss.
- 12.7.2. If possible, we suggest customer to use up all modules in six months. If the module storage time over twelve months, we suggest that recheck it before the module be used.
- 12.7.3. After the product shipped, any product quality issues must be feedback within three months, otherwise, we will not be responsible for the subsequent or consequential events.

	_	_					
1	3.	Рa	C	ĸa	aı	n	α

TBD

# 14. Outline Drawing

